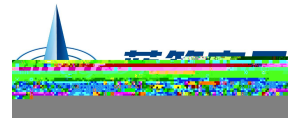


版本	修订日期	有修订的页码	修订涉及的内容	拟制	审核
A	2021.12.22	ALL	基于 AOS-AON6242(参考其他)+AOB66616L(参考 PD+RJ)规格书制订， 芯片测试数据参考 N0206DM 新芯片	庞隆基	陈逸晞



TO-263 塑封封装 N 沟道场效应管。

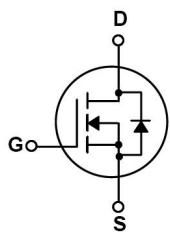
N-CHANNEL MOSFET in a TO-263 Plastic Package.

低电阻,开关速度快,无卤产品。

Ultra Low On-Resistance,fast switching,Halogen-free Product.

该器件适用于高效电源模块,主动式 PFC 电路和基于半桥拓扑结构的电子节能灯。

These devices are well suited for high efficient switched mode power supplies, Active power factor correction, electronic lamp ballast based on half bridge topology.

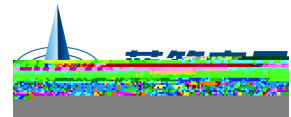


PIN1 : G

PIN 2、4 : D

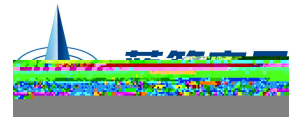
PIN 3 : S

见印章说明。 See Marking Instructions.

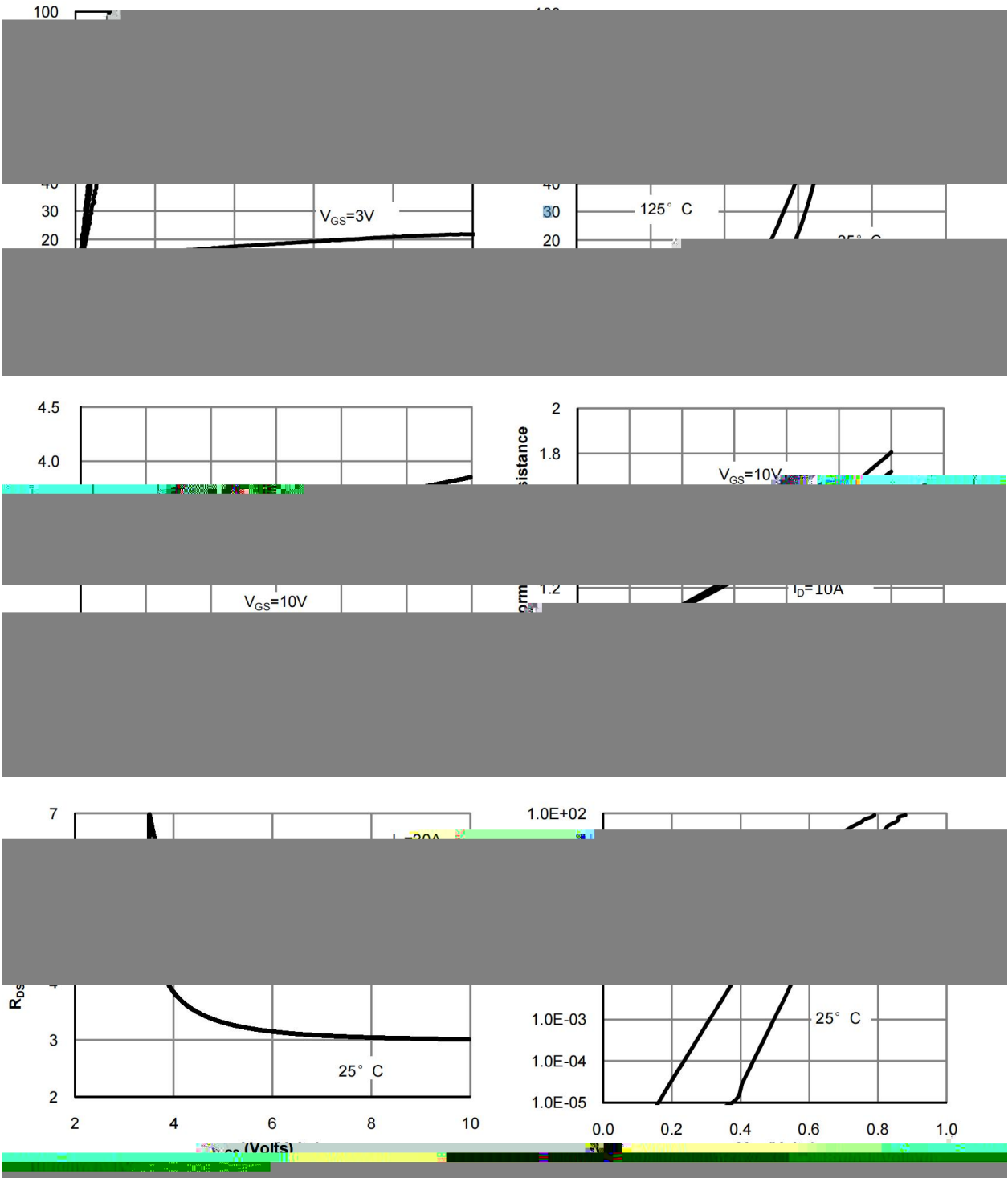


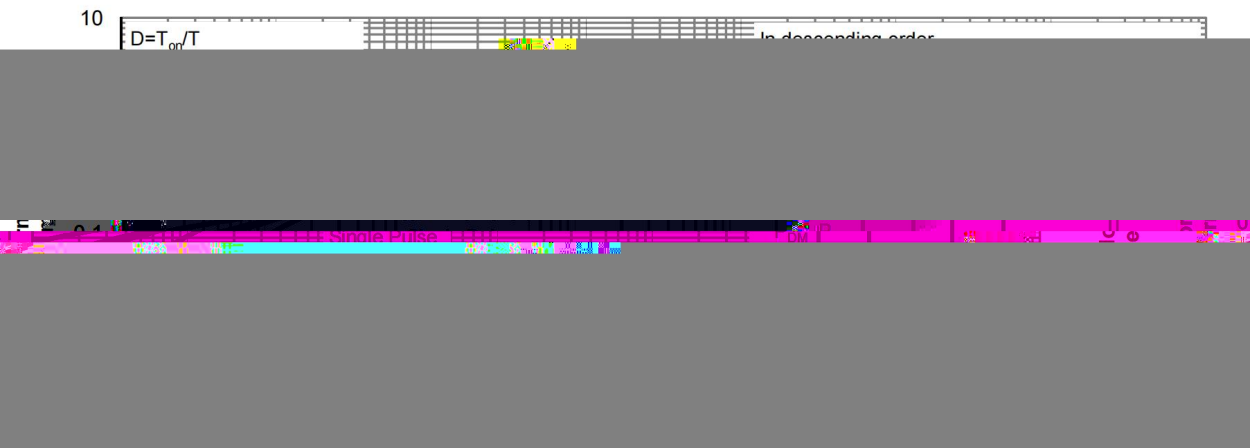
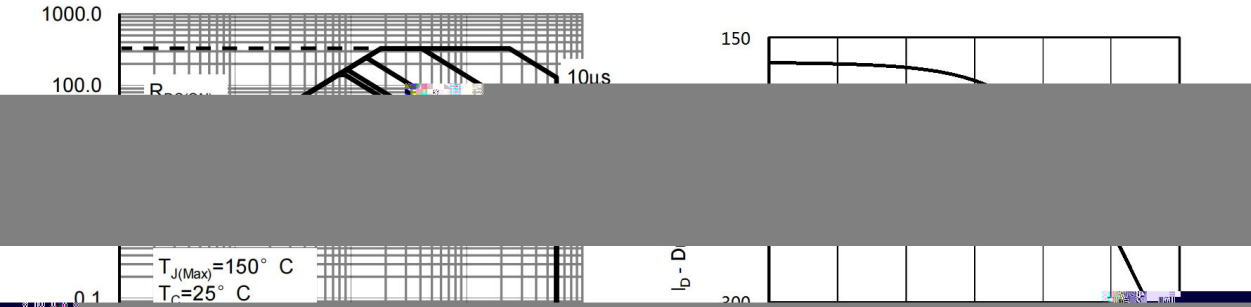
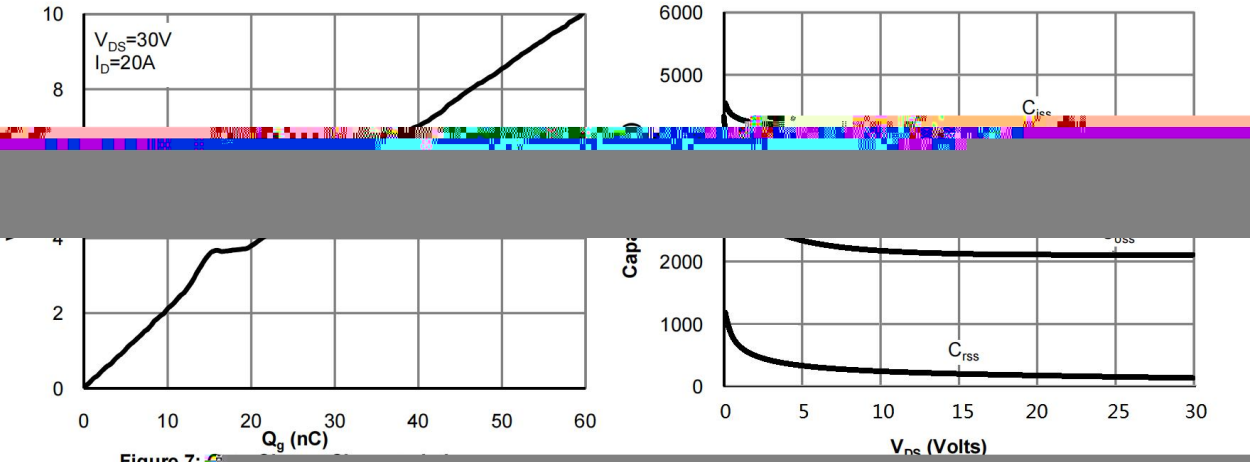
Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V _{DSS}	60	V
Drain Current		I _D (Tc=25°C)	140	A
Pulsed Drain Current		I _{DM}	330	A
Gate-Source Voltage		V _{GS}	±20	V
Single Pulsed Avalanche Energy L=0.5mH		E _{AS}	191	mJ
Avalanche Current		I _{AS}	27	A
Total Power Dissipation		P _D (Tc=25°C)	125	W
Junction and Storage Temperature Range		T _J ,T _{STG}	-55 to 150	°C
Thermal Resistance-Junction to Ambient	t≤10s	R θ JA	15	°C/W
	Steady-State		60	
Thermal Resistance-Junction to Case	Steady-State	R θ JC	1.0	

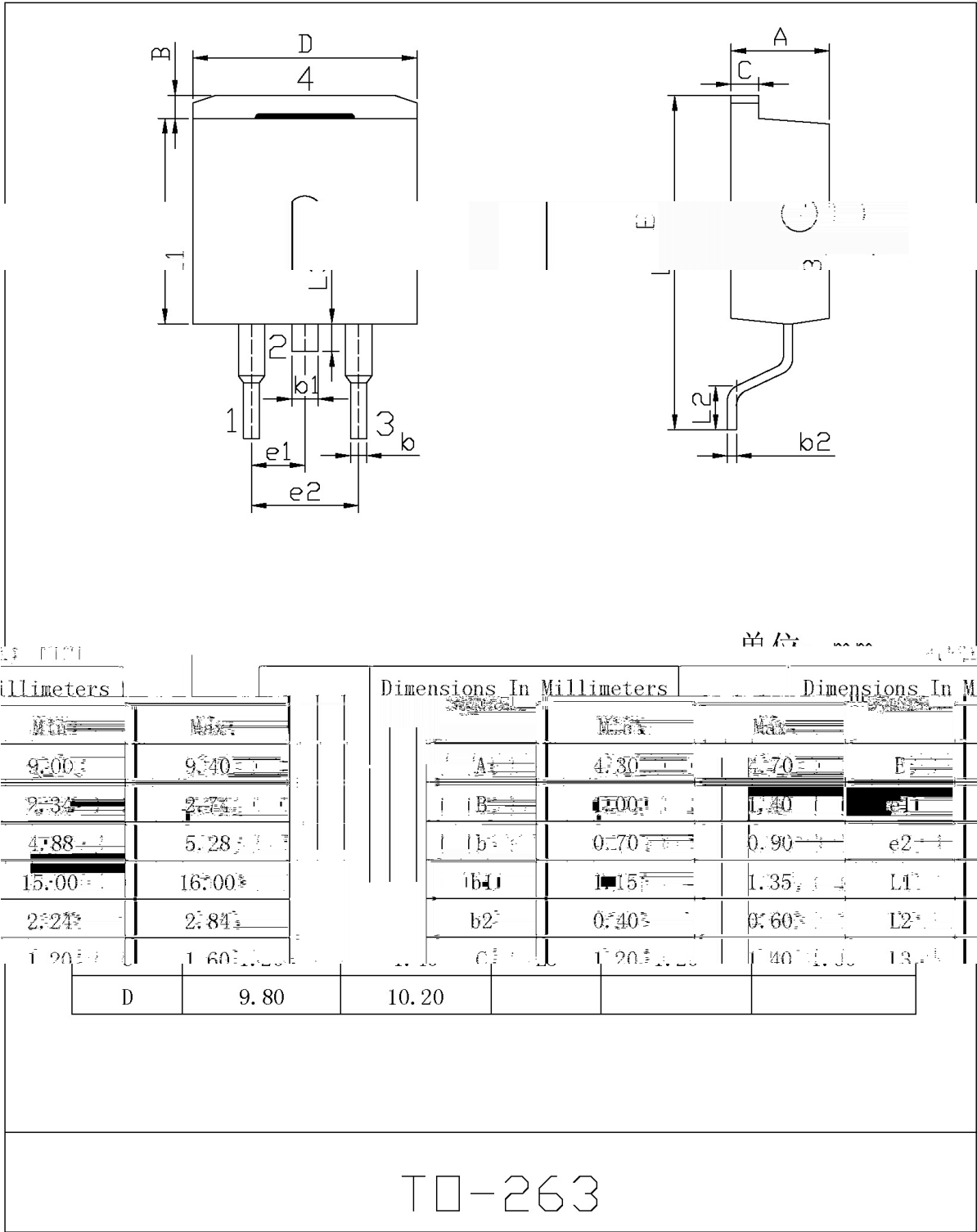
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0\text{V}$ $I_D=250\mu\text{A}$	60	70		V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60\text{V}$ $V_{GS}=0\text{V}$			1	μA
Gate-Body Leakage Current Forward	I_{GSS}	$V_{GS}=\pm 20\text{V}$ $V_{DS}=0\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=250\mu\text{A}$	1	2.0	3	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}$ $I_D=20\text{A}$		2.9	3.2	m Ω
		$V_{GS}=4.5\text{V}$ $I_D=10\text{A}$		3.5	4.2	
Forward On Voltage	V_{SD}	$V_{GS}=0\text{V}$ $I_S=1\text{A}$			1.2	V
Gate resistance	R_g	$f=1\text{MHz}$		1.7		Ω
Input Capacitance	C_{iss}	$V_{DS}=25\text{V}$ $V_{GS}=0\text{V}$ $f=1\text{MHz}$		4100		pF
Output Capacitance	C_{oss}			2160		
Reverse Transfer Capacitance	C_{rss}			180		

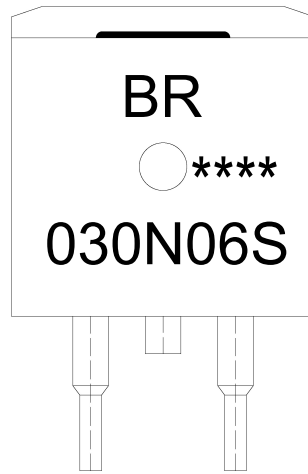
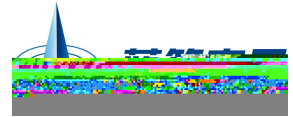


Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Total Gate Charge	$Q_g(10V)$	$V_{GS}=10V$ $V_{DS}=30V$ $I_D=20A$		60		nC
Total Gate Charge	$Q_g(4.5V)$			23		
Gate Source Charge	Q_{gs}			16		
Gate Drain Charge	Q_{gd}			3		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10V$ $V_{DS}=20V$ $R_L=1\Omega$ $R_{GEN}=3\Omega$		13		ns
Turn-On Rise Time	t_r			4		









BR

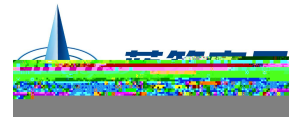
030N06S

Note:

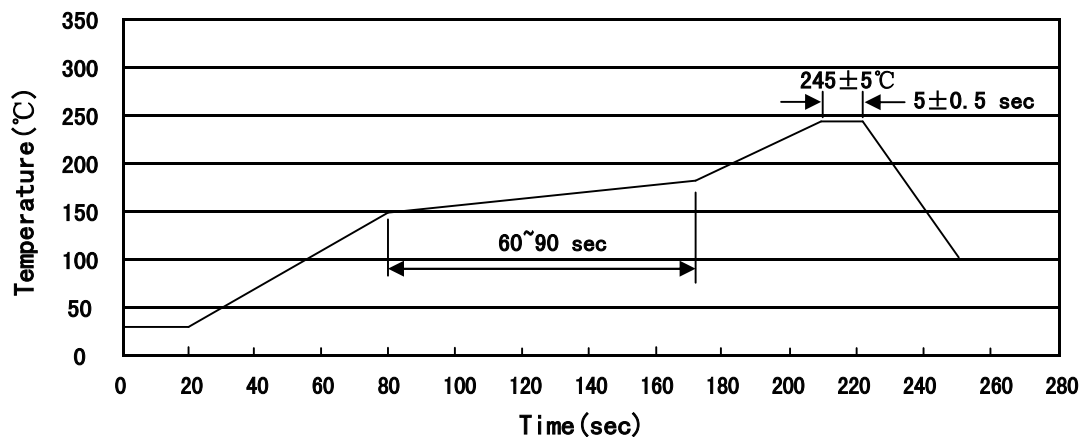
BR: Company Code

030N06S: Product Type.

****: Lot No. Code, code change with Lot No.



Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|----|-----------|--|
| 1 | 150 | 180 | 60 | 90sec; | 1.Preheating:150~180°C, Time:60~90sec. |
| 2 | 245±5 | | | 5±0.5sec; | 2.Peak Temp.:245±5°C, Duration:5±0.5sec. |
| 3 | | | 2 | 10°C/sec. | 3. Cooling Speed: 2~10°C/sec. |

260±5°C

10±1 sec.

Temp.:260±5°C

Time:10±1 sec

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
TO-263	800	1	6	5	4,800	13" ×24	360×360×50	380×335×366

/ TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-263	50	20	1,000	5	5,000	532×33×7.0	555×164×50	575×290×180